

# MCB 1005 B Specification

**Product Name** 

Series

Size

**Chip Ferrite Bead** 

**MCB B Series** 

**EIAJ 1005** 





# Chip Ferrite Bead (MCB-B Series) Engineering Spec.

This product belongs to the industrial grade standard, not the vehicle gauge product! Can not use auto parts, if the customer is not expressly informed and privately used to auto parts, produce any consequences, the original is not responsible for after-sales service, thank you!

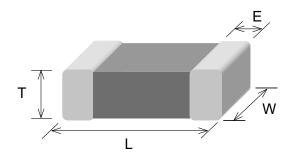
## **■**FEATURES

- Monolithic inorganic material construction
- Closed magnetic circuit avoids crosstalk
- SMD Type & suitable for reflow and wave soldering
- Available in various sizes
- Excellent solderability and heat resistance
- High reliability
- Effectively filtering capability over a wide range of frequency

## ■ APPLICATIONS

Filtering between analog and digital circuitry,clock generation circuitry,I/O interconnects, isolation between RF noisy circuits and logic devices susceptible to functional degradation ,power supply filtering to prevent conducted RF energy from corrupting the power generation circuitry,high frequency EMI prevention of computer, printers, VCRs, TVs and portable telephons

## ■ SHAPES AND DIMENSIONS



| TYPE | 1005            |  |
|------|-----------------|--|
|      | (EIA 0402)      |  |
| L    | $1.00 \pm 0.10$ |  |
| W    | $0.50 \pm 0.10$ |  |
| Т    | $0.50 \pm 0.10$ |  |
| Е    | $0.25 \pm 0.10$ |  |
| Unit | mm              |  |



## ■ PART NUMBER CODE

MCB 1005 B <u>B</u> <u>P</u>

- 1 Series Name
- 2 Size Code: the first two digitals : length(mm), the last two digitals : width(mm)
- 3 Material Code
- 4 Impedance at 100 MHz (ex:  $600=60\Omega$ ;  $121=120\Omega$ )
- 6 Rated Current Code

| A=50mA  | B=80mA  | C=100mA  | D=150mA  | E=200mA | F=300mA |
|---------|---------|----------|----------|---------|---------|
| G=400mA | H=500mA | I =600mA | J =700mA | K=800mA |         |

- 7 Soldering: Green Parts: A— Soldering Lead-Free B— Lead-Free for whole chip
- 8 Packaging: P Paper tape, 7" reel.

## ■ PART NUMBER AND CHARACTERISTICS TABLE

| Part No.           | Impedance(Ω)<br>+/-25%                       | Test Freq.<br>(MHz) | DCR(Ω)<br>(Max.) | Rated Current (mA) |
|--------------------|--|---------------------|------------------|--------------------|
| MCB1005B601FBP     | 600  | 100                 | 0.60             | 300                |
| MCB1005B102EBP     | 1000   | 100                 | 1.00             | 200                |
| MCB1005B152DBP     | 1500   | 100                 | 1.50             | 150                |
| MCB1005B182DBP     | 1800   | 100                 | 1.50             | 150                |
|                    | •Test Level: 250 mV                          |                     |                  |                    |
|                    | •HP4291B RF IMPEDANCE / MATERIAL ANALYZER    |                     |                  |                    |
| Test Instruments:  | •HP4338A/B MILLIOHMMETER                     |                     |                  |                    |
| rest mistraments : | •Agilent 8720ES S-PARAMETER NETWORK ANALYZER |                     |                  |                    |
|                    | •HP6632B SYSTEM DC POWER SUPPLY              |                     |                  |                    |

<sup>\*\*</sup> For special part number which is not shown in the above table, please refer to appendix.

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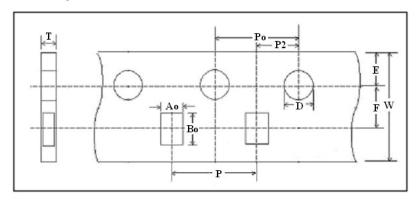
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# ■ TAPE AND REEL SPECIFICATIONS

#### PAPER CARRIER



# ■ TAPING DIMENSIONS

Unit: mm

| Size   | 1005      |  |
|--------|-----------|--|
| Symbol | PAPER     |  |
| W      | 8.00±0.10 |  |
| Р      | 2.00±0.05 |  |
| E      | 1.75±0.05 |  |
| F      | 3.50±0.05 |  |
| D      | 1.55±0.05 |  |
| D1     | NA        |  |
| Po     | 4.00±0.10 |  |
| Po10   | NA        |  |
| P2     | 2.00±0.05 |  |
| Ao     | 0.62±0.03 |  |
| Во     | 1.12±0.03 |  |
| Ko(T)  | 0.60±0.03 |  |
| t      | NA        |  |

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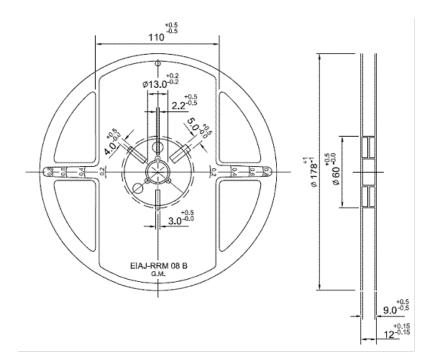
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# ■ REEL DIMENSIONS

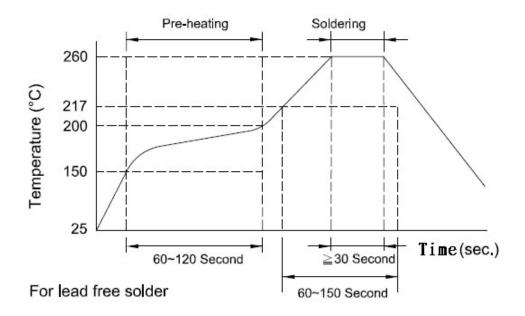


Unit:

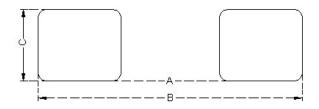
| 7" Reel Packaging Quantity |                     |  |
|----------------------------|---------------------|--|
| PART SIZE                  | 1005                |  |
| (EIA SIZE)                 | (0402)              |  |
| 7" REEL 10,000             |                     |  |
| BOX                        | 5 reels / inner box |  |



# ■ RECOMMENDED SOLDERING CONDITIONS



## ■ LAND PATTERNS FOR REFLOW SOLDERING



# ■ SOLDER LAND INFORMATION

Unit: mm (inches)

| Size(mm) | А       | В                    | С       |
|----------|---------|----------------------|---------|
| 1005     | 0.4     | 1.2 ~ 1.4            | 0.5     |
| 1005     | (0.016) | $(0.047 \sim 0.055)$ | (0.020) |

## ■ GENERAL TECHNICAL DATA

Operating temperature range : -  $55^{\circ}$ C ~ +125 $^{\circ}$ C Storage Condition : Less than 40 $^{\circ}$ C and 70% RH

Storage Time: 6 months Max. Soldering method: Reflow

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# ■ RELIABILITY AND TEST CONDITION

| Test item                    | Test condition   | Criteria  |
|------------------------------|--|---|
| Temperature Cycle            | <ul> <li>a. Temperature : - 55°C ~ +125°C</li> <li>b. Cycle : 100 cycles</li> <li>c. Dwell time : 30minutes</li> <li>d. Measurement : at ambient temperature 24 hrs after test completion</li> </ul>   | <ul> <li>a. No mechanical damage</li> <li>b. Impedance value should</li> <li>be within ± 20 % of the</li> <li>initial value</li> </ul>  |
| Operational Life             | <ul> <li>a. Temperature : 125°C ± 5°C</li> <li>b. Test time : 1000 hrs</li> <li>c. Apply current : full rated current</li> <li>d. Measurement : at ambient temperature 24 hrs after test completion</li> </ul>                               | <ul> <li>a. No mechanical damage</li> <li>b. Impedance value should</li> <li>be within ± 20 % of the</li> <li>initial value</li> </ul>  |
| Biased Humidity              | <ul> <li>a. Temperature: 40°C ± 2°C</li> <li>b. Humidity: 90 ~ 95 % RH</li> <li>c. Test time: 1000 hrs</li> <li>d. Apply current: full rated current</li> <li>e. Measurement: at ambient temperature 24 hrs after test completion</li> </ul> | <ul> <li>a. No mechanical damage</li> <li>b. Impedance value should</li> <li>be within ± 20 % of the initial value</li> </ul>   |
| Resistance to Solder<br>Heat | a. Solder temperature : 260 ± 5℃ b. Flux : Rosin c. DIP time : 10 ± 1 sec  | <ul> <li>a. More than 95 % of terminal electrode should be covered with new solder</li> <li>b. No mechanical damage</li> <li>c. Impedance value should be within ± 20 % of the initial value</li> </ul> |
| Adhesive Test                | <ul> <li>a. Reflow temperature : 245°C It shall be Soldered on the substrate</li> <li>applying direction parallel to the substrate</li> <li>b. Apply force(F) : 5 N</li> <li>c. Test time : 10 sec</li> </ul>                                | <ul> <li>a. No mechanical damage</li> <li>b. Soldering the products         on PCB after the pulling         test force &gt; 5 N</li> </ul>   |

| MCR 1005 | R Sarias | Fnginger | Specification |
|----------|----------|----------|---------------|
|          |          |          |               |



| Test item          | Test condition   | Criteria   |
|--------------------|--|--|
| Steam Aging        | <ul> <li>a. Temperature : 93°C</li> <li>b. Test time : 4 hrs</li> <li>c. Solder temperature : 235 ± 5°C</li> </ul> |  |
| Test               | d. Flux : Rosin e. DIP time : 5 ± 1 sec  | with new solder  |
| Rated Current Test | a. Apply current : full rated current / 5min   | Temperature rise should be less than 25 $\!$ |